

Super Junction MOSFET

N-Channel Super Junction MOSFET

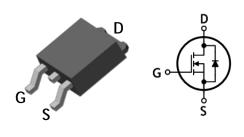
Package

Features

- Drain-Source voltage: V_{DS}=750V (@T_J=150°C)
- Low drain-source On resistance: $R_{DS(on)}=0.81\Omega$ (Typ.)
- Ultra low gate charge: Qg=10nC (Typ.)
- RoHS compliant device
- 100% avalanche tested

Ordering Information

Part Number

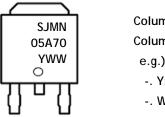


TO-252

SJMN05A70D SJMN05A70 TO-252

Marking

Marking Information



Column 1, 2: Device Code Column 3: Production Information e.g.) YWW -. Y: Year Code -. WW : Week Code

Absolute maximum ratings (Tc=25°C unless otherwise noted)

Characteristic		Symbol	Rating	Unit
Drain-source voltage		V _{DSS}	700	V
Gate-source voltage		V _{GSS}	±30	V
Drain current (DC) ^(Note 1)		T _c =25°C	5	А
	ID	T _c =100°C	3.2	А
Drain current (Pulsed) (Note 1)		I _{DM}	15	А
Single pulsed avalanche energy (Note 2)		E _{AS}	130	mJ
Repetitive avalanche current (Note 1)	I _{AR}		5	А
Repetitive avalanche energy (Note 1)		E _{AR}	0.4	mJ
Power dissipation		P _D	50	W
Junction temperature		TJ	150	°C
Storage temperature range		T _{stg}	-55~150	°C

* Limited only maximum junction temperature

Thermal Characteristics

Characteristic	Symbol	Rating	Unit
Thermal resistance, junction to case	R _{th(j-c)}	Max. 2.5	°C/W
Thermal resistance, junction to ambient	$R_{th(j-a)}$	Max. 62	-C/ W

Electrical Characteristics (T_A=25°C unless otherwise noted)

Characteristic	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Drain-source breakdown voltage	BV _{DSS}	I _D =250uA, V _{GS} =0V	700	-	-	V
Gate threshold voltage	V _{GS(th)}	$I_D=250uA, V_{DS}=V_{GS}$	2.5	3.5	4.5	V
Drain-source cut-off current		V_{DS} =700V, V_{GS} =0V	-	-	1	uA
Drain-source cut-off current	I _{DSS}	V _{DS} =560V, T _J =125°C	-	-	10	uA
Gate leakage current	I _{GSS}	$V_{DS}=0V, V_{GS}=\pm 30V$	-	-	±100	nA
Drain-source on-resistance	R _{DS(ON)}	V _{GS} =10V, I _D =1.5A	-	0.81	0.92	Ω
Gate resistance	R _G	f=1MHz, Open drain	-	2.0	-	Ω
Input capacitance	C _{iss}	V _{DS} =25V, V _{GS} =0V, f=1MHz	-	450	-	pF
Output capacitance	C _{oss}		-	320	-	
Reverse transfer capacitance	C _{rss}		-	9	-	
Turn-on delay time (Note 3)	t _{d(on)}		-	13	-	
Rise time (Note 3)	t _r	V_{DS} =300V, I_{D} =2A,	-	12	-	
Turn-off delay time (Note 3)	t _{d(off)}	$R_{G}=12\Omega$, $V_{GS}=10V$	-	31	-	ns
Fall time (Note 3)	t _f		-	9	-	
Total gate charge (Note 4)	Qg		-	10	-	
Gate-source charge (Note 4)	Q _{gs}	$V_{DS}=480V, V_{GS}=10V,$ $I_{D}=2A$	-	3.5	-	nC
Gate-drain charge (Note 4)	Q_{gd}		-	3	-	Ţ

Source-Drain Diode Ratings and Characteristics (Tc=25°C unless otherwise noted)

Characteristic	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Source current (DC)	ls	Integral reverse diode	-	-	5	А
Source current (Pulsed)	I _{SM}	in the MOSFET	-	-	15	А
Forward voltage	V _{SD}	$V_{GS}=0V$, $I_S=2A$	-	-	1.2	V
Reverse recovery time (Note 3,4)	t _{rr}	I _s =4A, V _R =50V,	-	220	-	ns
Reverse recovery charge (Note 3,4)	Q _{rr}	dl _s /dt=100A/us	-	1.6	-	uC

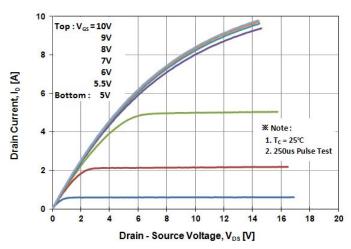
Note:

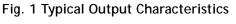
1. Calculated continuous current based on maximum allowable junction temperature

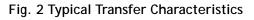
2. L=60mH, I_{AS} =2A, V_{DD} =60V, R_G =25 Ω , Starting T_J =25°C 3. Guaranteed by design, not subject to production testing

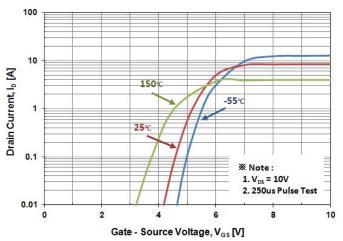
4. Pulse test: Pulse width≤300us, Duty cycle≤2%

Typical Electrical Characteristics Curves

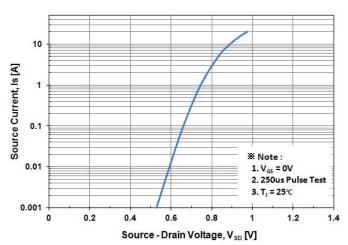


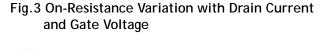


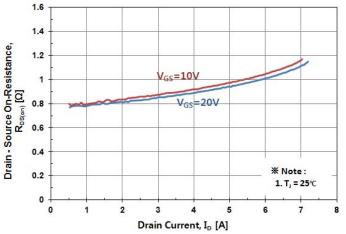


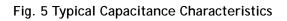












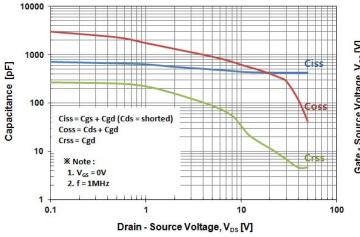
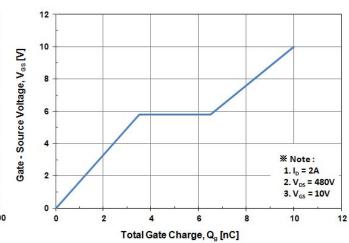


Fig. 6 Typical Total Gate Charge Characteristics



X Note :

125

1. V_{GS} = 10V

2. I_D = 1.5A

150

175

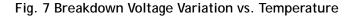
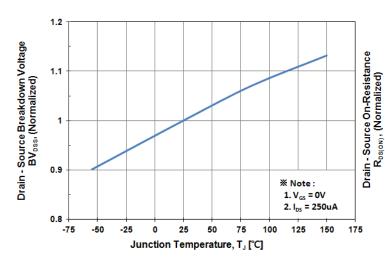
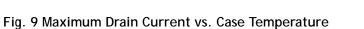


Fig. 8 On-Resistance Variation vs. Temperature







25

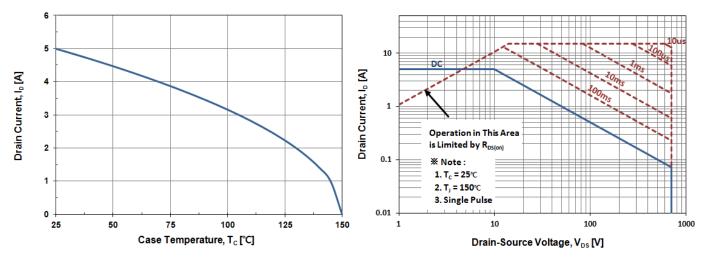
Junction Temperature, T_J [°C]

0

50

75

100



3

2.5

2

1.5

1

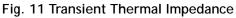
0.5

0

-75

-50

-25



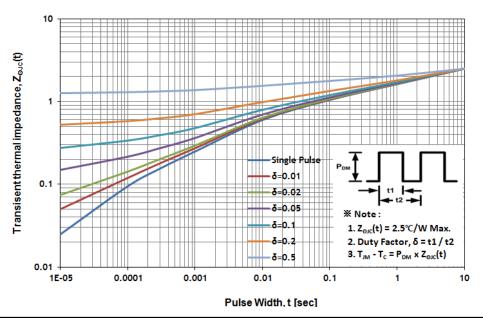


Fig. 12 Gate Charge Test Circuit & Waveform

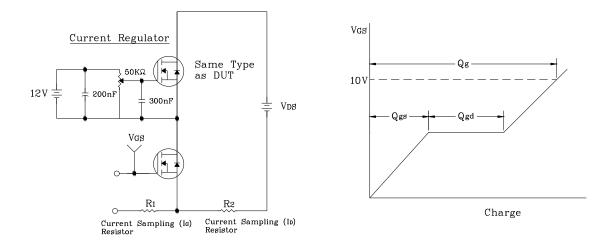


Fig. 13 Resistive Switching Test Circuit & Waveform

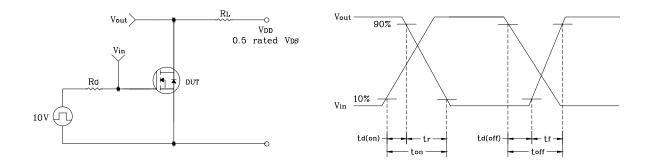


Fig. 14 E_{AS} Test Circuit & Waveform

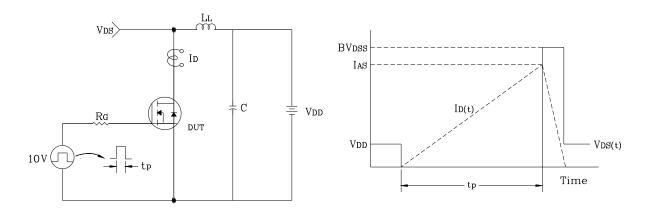
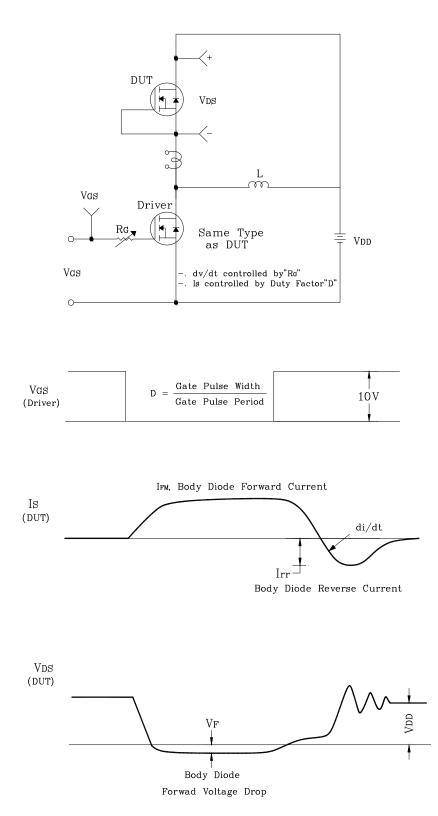
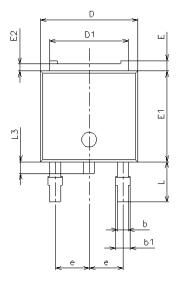
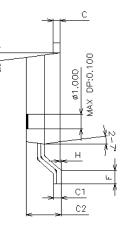


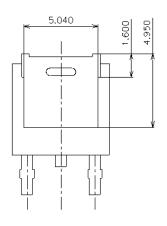
Fig. 15 Diode Reverse Recovery Time Test Circuit & Waveform



Package Outline Dimensions (Unit: mm)



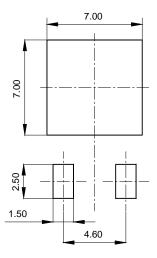




A-7°		
\triangleleft		
V		
		Ā

SYMBOL	MILLIMETERS			
STINIBUL	MINIMUM	NOMINAL	MAXIMUM	NOTE
D	6.40	6.60	6.80	
D1	5.14	5.34	5.54	
E	0.50	0.70	0.90	
E1	5.90	6.10	6.30	
E2		0.50 TYP		
Α	2.20	2.30	2.40	
A1	0.87	1.07	1.27	
С	0.40	0.50	0.60	
C1	0.40	0.50	0.60	
C2	2.10	2.30	2.50	
L	2.50	2.70	2.90	
L3	0.60	0.80	1.00	
b	0.66	0.76	0.86	
b1	0.96 MAX			
e	2.10	2.30	2.50	
F	0.80 MIN			
н	0.00	-	0.10	

Recommended Land Pattern (Unit: mm)



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